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| SERIAL NUMBER 10/717,547 | FILING DATE 11/21/2003 RULE | CLASS 438 | GROUP ART UNIT 1765 | ATTORNEY DOCKET NO. 31869-198826 |
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APPLICANTS

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*JK*** CONTINUING DATA *****
JK

** FOREIGN APPLICATIONS *****

JAPAN 2002-339699 11/22/2002
JAPAN 2003-378076 11/07/2003
JK

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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|---|------------------------------|------------------------|-----------------------|----------------------------|
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| 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance <i>JK</i> | | | | |
| Verified and Acknowledged | Examiner's Signature | Initials | | |

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TITLE

Surface treatment method for a compound semiconductor layer and method of fabrication of a semiconductor device

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| FILING FEE | FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT | <input type="checkbox"/> All Fees |
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